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ATTACHMENT

TO PAPER NO.

FORM PTO-892

U.S. DEPARTMENT OF COMMERCE SERIAL NO. GROUP ART UNIT

O9/756649

GROUP ART

UNIT

3742

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EXAMINER

John A. Jeffery

DATE July 8, 2002

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* A copy of this reference is not being furnished with this office action. (See Manual of Patent Examining Procedure, section 707.05(a).)